

PCN Number: PCN-2020-135

PCN Notification Date: 07/17/2020

Informational PCN

Packing method change from 'Tube' to 'Tray'
for the material in the QFN package

Dear Customer,

This notification is to advise you of the following change(s):

The packing method of material in the QFN package has been changed from 'Tube' to 'Tray' because 'Tray' is the standard shipping method for Cirrus Logic's QFN devices.

Consequently, MOQ (Minimum Order Quantity) has been changed from '123 pcs' to '490 pcs' for the material in 4 x 4 mm QFN package and from '60 pcs' to '490 pcs' for the material in 5 x 5 mm QFN package.

No additional qualification is required for this change since the 'Tray' packing is already one of Cirrus standard packing methods. As such, the described change(s) within this PCN is effective immediately from this PCN notification or once the current inventories in the tube packing are all used.

Cirrus Logic would like to take this opportunity to thank our customers for their cooperation and assistance in this respective matter. Any specific or immediate inquiries should be directed to your local Field Sales Representative.

If you have any questions, please contact your Sales Representative.

Sincerely,

Quality Systems Administrator
Cirrus Logic Corporate Quality
Phone: +1(512) 851-4000



Process Change Notification

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Products Affected:

The device(s) listed on this page are the complete list of affected devices. According to our records, these are the device(s) that you have purchased or been sampled within the past twenty-four (24) months.

Technical details of this Process / Product Change follow on the next page(s).

Title:		Packing method change from 'Tube' to 'Tray' for the material in the QFN package			
Customer Contact:		Local Field Sales Representative	Phone:	(512) 851-4000	Dept: Corporate Quality
Proposed 1st Ship Date:		Immediately	Estimated Sample Availability Date:		NA
Change Type:					
	Assembly Site		Assembly Process		Assembly Materials
	Wafer Fab Site		Wafer Fab Process		Wafer Fab Materials
	Wafer Bump Site		Wafer Bump Process		Wafer Bump Material
	Test Site		Test Process		Design
	Electrical Specification		Mechanical Specification		Part Number
X	Packing/Shipping/Labeling	X	Other		
Comments:		MOQ changes from 123 pcs to 490 pcs for 4 x 4 mm QFN and from 60 pcs to 490 pcs for 5 x 5 QFN.			

PCN Details																													
Description of Change:																													
<ul style="list-style-type: none"> Packing method change: 																													
<table border="1"> <thead> <tr> <th>From</th> <th>To</th> </tr> </thead> <tbody> <tr> <td>Tube</td> <td>Tray</td> </tr> </tbody> </table>			From	To	Tube	Tray																							
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WM8731CLSEFL	60	490																											
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WM8750CJLGEFL	60	490																											
WM8904CGEFL/V	123	490																											
WM8985CGEFL	60	490																											
WM8918CGEFL/V	123	490																											

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- **Packing condition and label information will not be changed:**

The packing condition includes MBB (Moisture Barrier Bag), HIC (Humidity Indicate Card) and desiccant will not be affected with this change per the JEDEC standard.

The label information will not be changed.

Reason for Change:

The Cirrus Logic's standard packing method for the QFN packages is 'Tray'. Cirrus Logic has harmonized to the standard for the listed devices.

Anticipated Impact on Form, Fit, Function, Quality or Reliability:

No impact to form, fit, quality or reliability. Impact to packing is as per the details described above. Customers may have to adjust Pick-N-Place system to adapt to the new packing type.

Reference Appendix A: Tray specification for 4 x 4 mm QFN

Reference Appendix B: Tray specification for 5 x 5 mm QFN

Anticipated Impact on Material Declaration:

- No Impact to the Material Declaration
 Material Declarations or Product Content reports are driven from production data and will be available following the production release.

Product Affected:

Cirrus Logic Part Number(s)
WM8731CLSEFL
WM8731CSEFL
WM8737CLGEFL
WM8750CBLGEFL
WM8750CJLGEFL
WM8904CGEFL/V
WM8985CGEFL
WM8918CGEFL/V

Changes To Product Identification Resulting From This PCN:

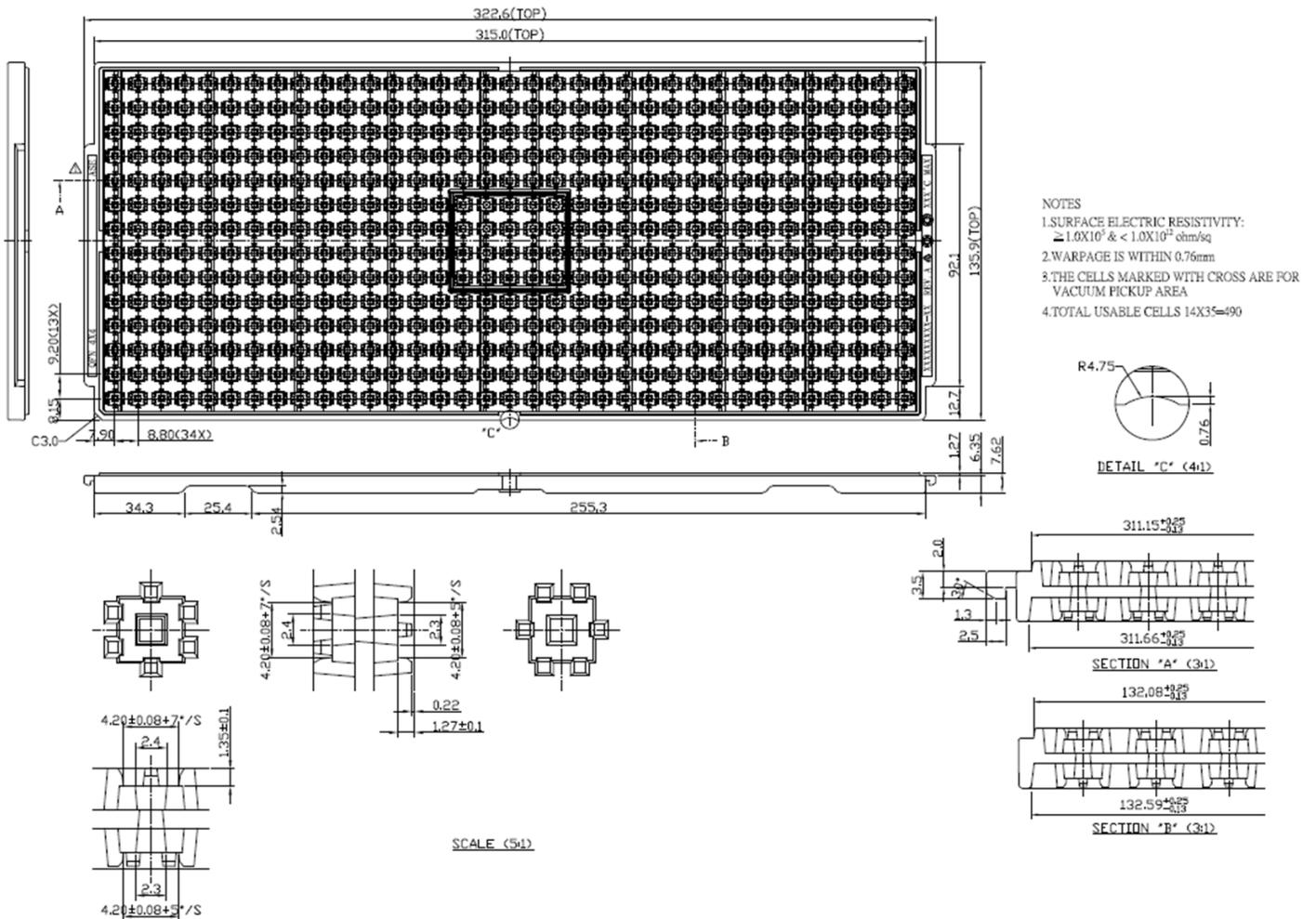
No marking changes.

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Appendix A: Tray Specification (Cirrus Logic spec No.: 3-SUPP-00071)

Tray specification for 4 x 4 mm QFN
 Cirrus Logic device: WM8904C, WM8918C



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Appendix B: Tray Specification (Cirrus Logic spec No.: 3-SUPP-00071)

Tray specification for 5 x 5 mm QFN

Cirrus Logic device: WM8731C, WM8737C, WM8750C, WM8985C

